

MOTOROLA
SEMICONDUCTOR
TECHNICAL DATA

MJE6040 thru MJE6045
See Page 3-139

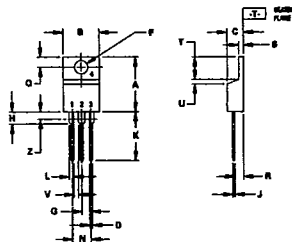
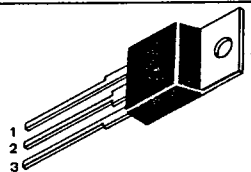
T-33-11
MJE8500
MJE8501

2.5 AMPERE
NPN SILICON
POWER TRANSISTORS

700 and 800 VOLTS
65 WATTS

Designer's Data for
"Worst Case" Conditions

The Designers Data Sheet permits the design of most circuits entirely from the information presented. Limit data - representing device characteristics boundaries - are given to facilitate "worst case" design.



MILLIMETERS		INCHES	
MIN	MAX	MIN	MAX
A	14.40	0.57	0.570
B	3.81	0.150	0.150
C	4.67	0.185	0.185
D	8.61	0.338	0.338
E	14.1	0.552	0.552
F	2.67	0.105	0.105
G	2.80	0.110	0.110
H	2.80	0.110	0.110
I	1.27	0.050	0.050
J	1.13	0.045	0.045
K	4.80	0.190	0.190
L	2.54	0.100	0.100
M	2.54	0.100	0.100
N	1.13	0.045	0.045
O	1.13	0.045	0.045
P	1.13	0.045	0.045
Q	1.13	0.045	0.045
R	1.13	0.045	0.045
S	1.13	0.045	0.045
T	1.13	0.045	0.045
U	1.13	0.045	0.045
V	1.13	0.045	0.045
W	1.13	0.045	0.045
X	1.13	0.045	0.045
Y	1.13	0.045	0.045
Z	1.13	0.045	0.045

STYLE 1
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: INCH.
3. DIM Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

CASE 221A-04
TO-220AB

Designers Data Sheet

SWITCHMODE SERIES
NPN SILICON POWER TRANSISTORS

The MJE8500 and MJE8501 transistors are designed for high-voltage, high-speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line operated switch-mode applications such as:

- Switching Regulators
- Inverters
- Solenoid and Relay Drivers
- Motor Controls
- Deflection Circuits

Fast Turn-Off Times

- 300 ns Inductive Fall Time - 25°C (Typ)
- 500 ns Inductive Crossover Time - 25°C (Typ)
- 900 ns Inductive Storage Time - 25°C (Typ)

Operating Temperature Range -65 to +125°C

100°C Performance Specified for:

- Reversed Biased SOA with Inductive Loads
- Switching Times with Inductive Loads
- Saturation Voltages
- Leakage Currents

MAXIMUM RATINGS

Rating	Symbol	MJE8500	MJE8501	Unit
Collector-Emitter Voltage	V _{CEO(sus)}	700	800	Vdc
Collector-Emitter Voltage	V _{CEV}	1200	1400	Vdc
Emitter Base Voltage	V _{EB}	8.0	8.0	Vdc
Collector Current - Continuous	I _C	2.5	2.6	Adc
Collector Current - Peak (1)	I _{CM}	5.0	5.0	Adc
Base Current - Continuous	I _B	2.0	2.0	Adc
Base Current - Peak (1)	I _{BM}	4.0	4.0	Adc
Total Power Dissipation @ T _C = 25°C	P _D	65	65	Watts
@ T _C = 100°C		17	17	
Derate above 25°C		0.65	0.65	W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +125		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	1.54	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T _L	275	°C

(1) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 10%.

MJE8500, MJE8501

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ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit	
OFF CHARACTERISTICS						
Collector-Emitter Sustaining Voltage (Table 1) ($I_C = 100\text{ mA}$, $I_B = 0$)	MJE8500 MJE8501	$V_{CE0(sus)}$	700 800	— —	— —	Vdc
Collector Cutoff Current ($V_{CEV} = \text{Rated Value}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CEV} = \text{Rated Value}$, $V_{BE(off)} = 1.5\text{ Vdc}$, $T_C = 100^\circ\text{C}$)		I_{CEV}	— —	— —	0.25 5.0	mAdc
Collector Cutoff Current ($V_{CE} = \text{Rated } V_{CEV}$, $R_{BE} = 50\ \Omega$, $T_C = 100^\circ\text{C}$)		I_{CER}	—	—	5.0	mAdc
Emitter Cutoff Current ($V_{EB} = 7.0\text{ Vdc}$, $I_C = 0$)		I_{EBO}	—	—	1.0	mAdc
SECOND BREAKDOWN						
Second Breakdown Collector Current with base forward biased	$I_{S/b}$	See Figure 12				
Clamped Inductive SOA with Base Reverse Biased	RBSOA	See Figure 13				
ON CHARACTERISTICS (1)						
DC Current Gain ($I_C = 0.5\text{ Adc}$, $V_{CE} = 5.0\text{ Vdc}$)	h_{FE}	7.5	—	—	—	
Collector-Emitter Saturation Voltage ($I_C = 1.0\text{ Adc}$, $I_B = 0.33\text{ Adc}$) ($I_C = 2.5\text{ Adc}$, $I_B = 1.0\text{ Adc}$) ($I_C = 1.0\text{ Adc}$, $I_B = 0.33\text{ Adc}$, $T_C = 100^\circ\text{C}$)	$V_{CE(sat)}$	— — —	— — —	2.0 5.0 3.0	Vdc	
Base-Emitter Saturation Voltage ($I_C = 1.0\text{ Adc}$, $I_B = 0.33\text{ Adc}$) ($I_C = 1.0\text{ Adc}$, $I_B = 0.33\text{ Adc}$, $T_C = 100^\circ\text{C}$)	$V_{BE(sat)}$	— —	— —	1.5 1.5	Vdc	
DYNAMIC CHARACTERISTICS						
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f_{test} = 1.0\text{ kHz}$)	C_{ob}	50	—	250	pF	
SWITCHING CHARACTERISTICS						
Resistive Load (Table 1)						
Delay Time	$(V_{CC} = 500\text{ Vdc}$, $I_C = 1.0\text{ A}$, $I_{B1} = 0.33\text{ A}$, $V_{BE(off)} = 5.0\text{ Vdc}$, $t_p = 50\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$)	t_d	—	0.045	0.20	μs
Rise Time		t_r	—	0.2	2.0	μs
Storage Time		t_s	—	1.0	4.0	μs
Fall Time		t_f	—	0.5	2.0	μs
Inductive Load, Clamped (Table 1)						
Storage Time	$(I_C = 1.0\text{ A(pk)}$, $V_{clamp} = 500\text{ Vdc}$, $I_{B1} = 0.33\text{ A}$, $V_{BE(off)} = 5\text{ Vdc}$, $T_C = 100^\circ\text{C}$)	t_{sv}	—	1.3	4.0	μs
Crossover Time		t_c	—	0.6	2.0	μs
Storage Time	$(I_C = 1.0\text{ A(pk)}$, $V_{clamp} = 500\text{ Vdc}$, $I_{B1} = 0.33\text{ A}$, $V_{BE(off)} = 5\text{ Vdc}$, $T_C = 25^\circ\text{C}$)	t_{sv}	—	0.9	—	μs
Crossover Time		t_c	—	0.5	—	μs
Fall Time		t_{fi}	—	0.3	—	μs

(1) Pulse Test: PW - 300 μs , Duty Cycle $\leq 2\%$.

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FIGURE 1 - DC CURRENT GAIN

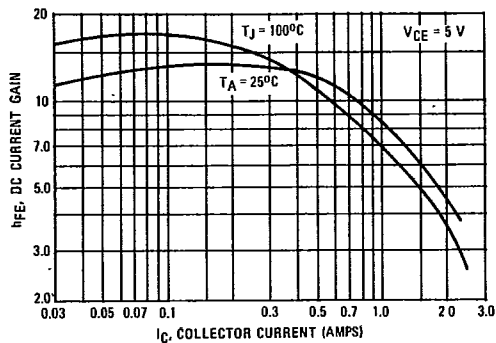


FIGURE 2 - COLLECTOR SATURATION REGION

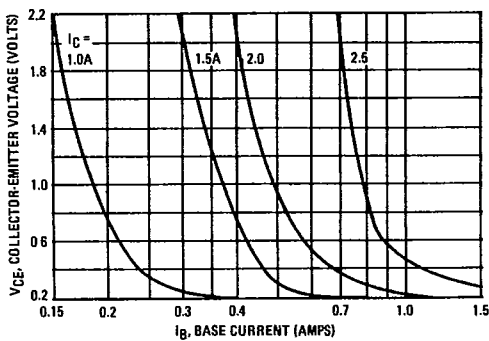


FIGURE 3 - COLLECTOR-EMITTER SATURATION VOLTAGE

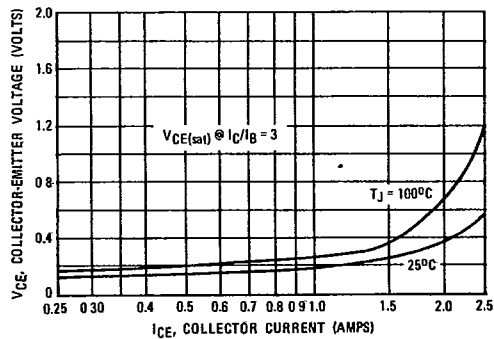


FIGURE 4 - BASE-EMITTER VOLTAGE

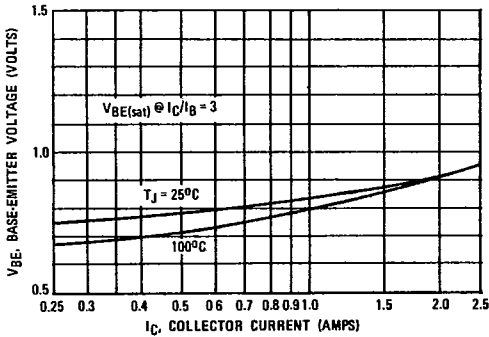


FIGURE 5 - COLLECTOR CUTOFF REGION

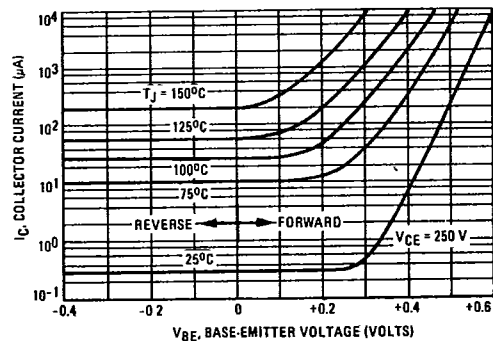
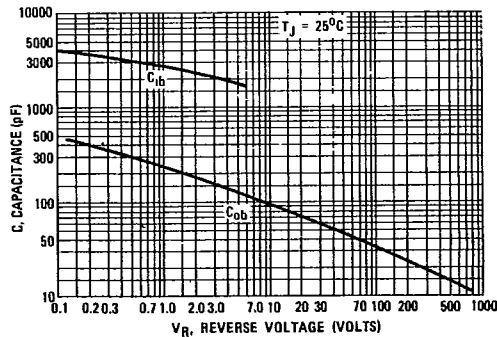


FIGURE 6 - CAPACITANCE



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FIGURE 7 - INDUCTIVE SWITCHING MEASUREMENTS

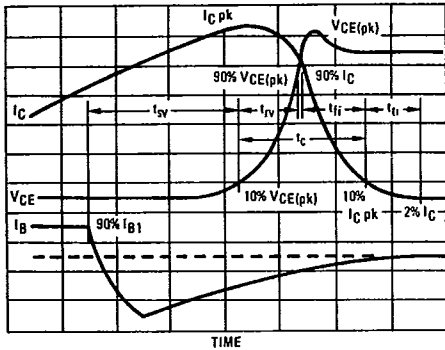
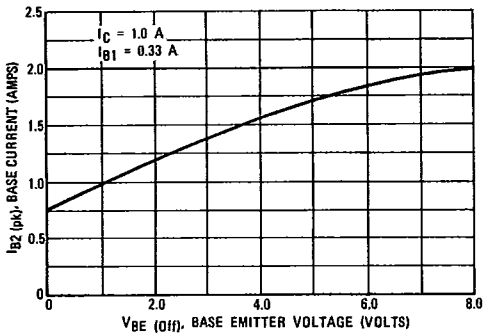


FIGURE 8 - PEAK REVERSE BASE CURRENT



TYPICAL RESISTIVE SWITCHING PERFORMANCE

FIGURE 9 - TURN - ON SWITCHING TIMES

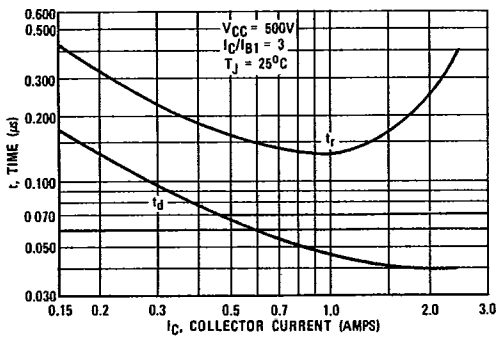
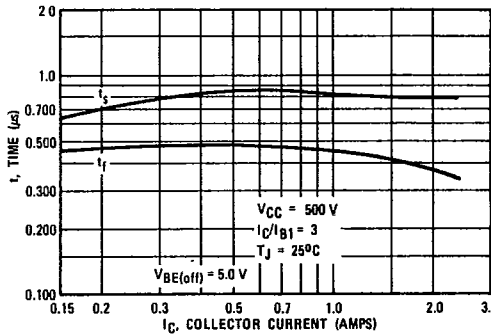


FIGURE 10 - TURN - OFF SWITCHING TIMES



SWITCHING TIMES NOTE

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

- t_{sv} = Voltage Storage Time, 90% I_{B1} to 10% $V_{CE(pk)}$
- t_{rv} = Voltage Rise Time, 10-90% $V_{CE(pk)}$
- t_{fi} = Current Fall Time, 90-10% I_C
- t_{ti} = Current Tail, 10-2% I_C
- t_c = Crossover Time, 10% $V_{CE(pk)}$ to 10% I_C

An enlarged portion of the inductive switching waveforms is shown in Figure 7 to aid in the visual identity of these terms.

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN-222:

$$P_{SWT} = 1/2 V_{CC} I_C (t_c) f$$

In general, $t_{rv} + t_{fi} \approx t_c$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25°C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a "SWITCHMODE" transistor are the inductive switching speeds (t_c and t_{sv}) which are guaranteed at 100°C.



TABLE 1 - TEST CONDITIONS FOR DYNAMIC PERFORMANCE

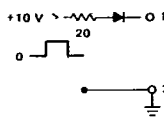
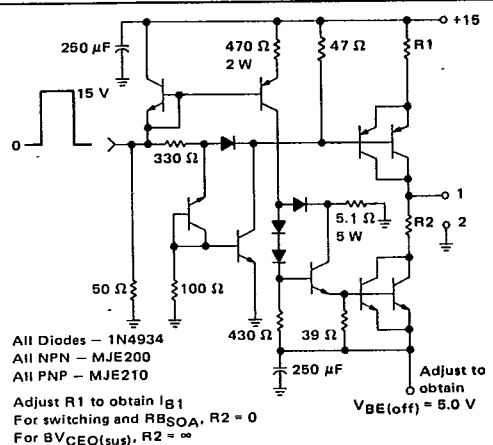
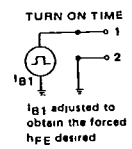
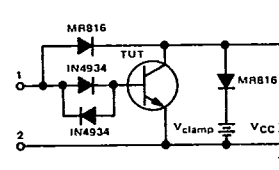
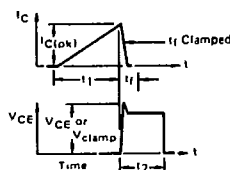
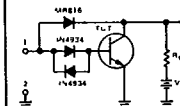
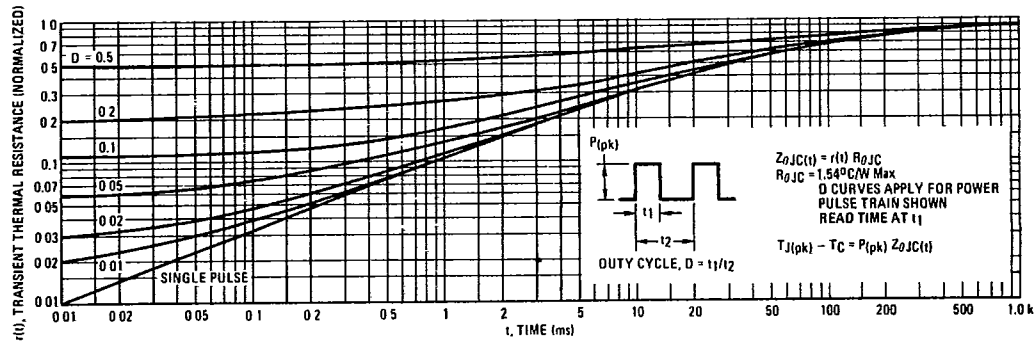
	V _{CEO(sus)}	RBSOA AND INDUCTIVE SWITCHING	RESISTIVE SWITCHING
INPUT CONDITIONS	 <p>+10 V 20 PW Varied to Attain I_C = 100 mA</p>	 <p>250 μF 15 V 330 Ω 470 Ω 2 W 47 Ω R1 50 Ω 100 Ω 5.1 Ω 5 W R2 39 Ω 250 μF Adjust to obtain V_{BE(off)} = 5.0 V</p> <p>All Diodes - 1N4934 All NPN - MJE200 All PNP - MJE210</p> <p>Adjust R1 to obtain I_{B1} For switching and RBSOA, R2 = 0 For BV_{CEO(sus)}, R2 = ∞</p>	 <p>TURN ON TIME I_{B1} I_{B1} adjusted to obtain the forced h_{FE} desired</p> <p>TURN OFF TIME Use inductive switching driver as the input to the resistive test circuit</p>
CIRCUIT VALUES	<p>L_{coil} = 80 mH V_{CC} = 10 V R_{coil} = 0.7 Ω</p>	<p>L_{coil} = 180 μH R_{coil} = 0.05 Ω V_{CC} = 20 V</p> <p>V_{clamp} = 500 V</p>	<p>V_{CC} = 500 V R_L = 500 Ω Pulse Width = 10 μs</p>
TEST CIRCUITS	<p>INDUCTIVE TEST CIRCUIT</p> 	<p>OUTPUT WAVEFORMS</p>  <p>t₁ Adjusted to Obtain I_C</p> $t_1 \approx \frac{L_{coil}(I_{Cpk})}{V_{CC}}$ $t_2 \approx \frac{L_{coil}(I_{Cpk})}{V_{clamp}}$ <p>Test Equipment Scope - Tektronix 475 or Equivalent</p>	<p>RESISTIVE TEST CIRCUIT</p> 

FIGURE 11 - THERMAL RESPONSE



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SAFE OPERATING AREA INFORMATION

FIGURE 12 - FORWARD BIAS SAFE OPERATING AREA

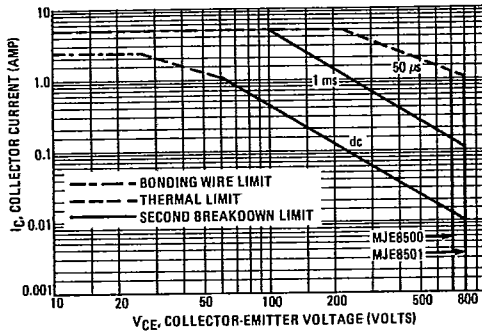


FIGURE 13 - RBSOA, REVERSE BIAS SWITCHING SAFE OPERATING AREA

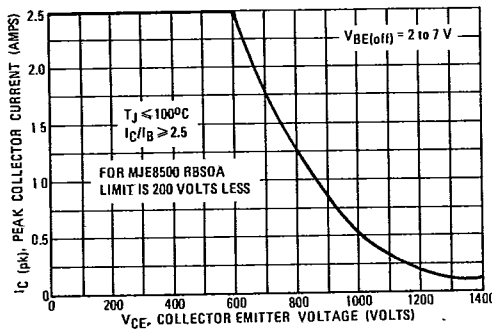
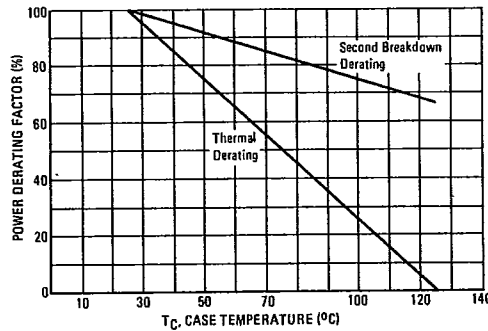


FIGURE 14 - POWER DERATING



FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C - V_{CE} limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 12 is based on $T_C = 25^\circ\text{C}$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25^\circ\text{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 12 may be found at any case temperature by using the appropriate curve on Figure 14.

$T_{J(pk)}$ may be calculated from the data in Figure 11. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current condition allowable during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 13 gives the complete RBSOA characteristics.

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